TOSHIBA PHOTOCOUPLER GaAs IRED & PHOTO-TRANSISTOR

TLP281, TLP281-4

PROGRAMMABLE CONTROLLERS AC/DC-INPUT MODULE PC CARD MODEM(PCMCIA)

TLP281 and TLP281-4 is a very small and thin coupler, suitable for surface mount assembly in applications such as PCMCIA Fax modem, programmable controllers.

TLP281 and TLP281-4 consist of photo transistor, optically coupled to a gallium arsenide infrared emitting diode.

Collector-Emitter Voltage : 80 V (min)
 Current Transfer Ratio : 50% (min)
 Rank GB : 100% (min)
 Isolation Voltage : 2500 Vrms (min)

UL Recognized : UL1577, File No. E67349
 BSI Approved : BS EN 60065: 2002,

: BS EN 60950-1: 2002 Certificate No. 8143, 8144 Unit: mm

TLP281

1 2

2.6 ± 0.25

7.0 ± 0.4

0.4 ± 0.1

1.27 ± 0.2

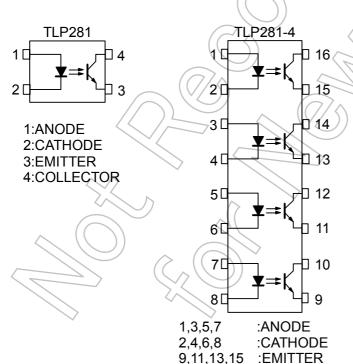
Half Pitch Mini Flat 4 pin

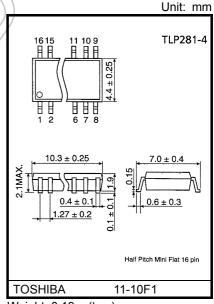
TOSHIBA

11-3A1

Weight: 0.05 g (typ.)

Pin Configuration (top view)





Weight: 0.19 g (typ.)

Start of commercial production 1996/03

10,12,14,16 :COLLECTOR

Current Transfer Ratio

TYPE	Classification(*1)	Current Transfer Ration (%) (I _C / I _F) I _F = 5 mA, V _{CE} = 5 V, Ta = 25°C		Marking of Classification
	Blank	Min 50	Max 600	Blank,Y [®] ,YE,G,G [®] ,GR,B,BL,GB
	Diank	30	000	blank, 1 , 1 L, G, G , GK, B, BL, GB
	Rank Y	50	150	YE
	Rank GR	100	300	GR
	Rank BL	200	600	BL
TLP281	Rank GB	100	600	GB
	Rank YH	75	150	Y*
	Rank GRL	100	200	G
	Rank GRH	150	300	G [®]
	Rank BLL	200	400	В
TLP281-4	Blank	50	600	Blank, GB
1LF 201-4	Rank GB	100	600	GB7/

^{*1:} Ex. rank GB: TLP281 (GB)

(Note): Application type name for certification test, please use standard product type name, i.e. TLP281 (GB): TLP281, TLP281–4 (GB): TLP281–4



Absolute Maximum Ratings (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RAT	UNIT	
	CHARACTERISTIC	STIVIBUL	TLP281	TLP281-4	UNIT
	Forward Current	lF	50		mA
	Forward Current Derating	ΔI _F /°C	−0.7 (Ta≥53°C)	-0.5 (Ta≥25°C)	mA /°C
ED	Pulse Forward Current (Note 1)	I _{FP}	,	1	<\A
	Reverse Voltage	V _R	Ę	5	V
	Junction Temperature	Tj	12	25	(°C
	Collector-Emitter Voltage	V _{CEO}	8	0	y
	Emitter-Collector Voltage	V _{ECO}	7		// v))
S	Collector Current	IC	5	mA	
DETECT	Collector Power Dissipation (1 Circuit)	P _C	150	100	mW
	Collector Power Dissipation Derating(Ta≥25°C) (1 Circuit)	ΔP _C /°C	-1.5	-1.0	mW /°C
	Junction Temperature	Tj	125		°C
Оре	erating Temperature Range	T _{opr}	-55 to 100		○ °C (
Storage Temperature Range		T _{stg}	-55 to 125		,c
Lead Soldering Temperature		T _{sol}	260 (10s)		(°c)
Total Package Power Dissipation (1 Circuit)		PT	200	170	mW)
Total Package Power Dissipation Derating (Ta≥25°C) (1 Circuit)		ΔP _T /°C	-1.7		mW /°C
Isola	ation Voltage (Note 2)	BV _S	2500(AC,1mi	n,R.H.≤60%)	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) Pulse width ≤ 100µs, frequency 100Hz

(Note 2) AC, 1 minute, R.H.≤60%,Device considered a two terminal device : LED side pins shorted together and DETECTOR side pins shorted together.

Individual Electrical Characteristics (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
	Forward Voltage	V _F	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse Current	IR	V _R = 5 V	_	_	10	μΑ
	Capacitance	c_{I}	V = 0, f = 1 MHz	_	30	_	pF
	Collector-Emitter Breakdown Voltage	V _(BR) CEO	I _C = 0.5 mA	80	_	_	٧
	Emitter-Collector Breakdown Voltage V(BR) ECO		I _E = 0.1 mA	7	_	_	٧
SR		ICEO	V _{CE} = 48 V	_	0.01	0.1	
DETECTOR	Collector Dark Current		Ambient Light Below (100 &x) (Note 4)	_	2	10	μΑ
DEI	(Note 3)		V _{CE} = 48 V, Ta = 85°C	_	2	50	
			Ambient Light Below (100 &x) (Note 4)	_	4	50	μA
	Capacitance (Collector to Emitter)	C _{CE}	V = 0, f = 1 MHz	_	10	_	pF

(Note 3) Because of the construction,leak current might be increased by ambient light. Please use photocoupler with less ambient light.

(Note 4) Irradiation to marking side using standard light bulb.

Coupled Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Current Transfer Ratio	I _C / I _F	I _F = 5 mA, V _{CE} = 5 V	50		600	%
Current Transfer Natio	IC / IF	Rank GB	100	_	600	70
Saturated CTR	la / l= / . »	IF = 1 mA, VCE = 0.4 V	1	60	1	%
Saturated CTR	I _C / I _{F (sat)}	Rank GB	30	/	_	70
		I _C = 2.4 mA, I _F = 8 mA	1) /_	0.4	
Collector-Emitter Saturation Voltage	V _{CE} (sat)	I _C = 0.2 mA, I _F = 1 mA) 	0.2	_	V
outuralisti voltago		Rank GB		-	0.4	
Off-State Collector Current	I _{C (off)}	V _F = 0.7 V, V _{CE} = 48 V		_	10	μΑ

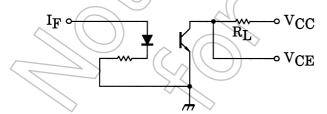
Isolation Characteristics (Ta = 25°C)

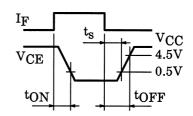
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Capacitance (Input to Output)	CS	V _S = 0 V, f = 1 MHz	7-6	0.8) —	pF
Isolation Resistance	R_S	V _S = 500 V, R.H. ≤ 60%	5×10 ¹⁰	1014	_	Ω
		AC, 1 minute	2500	<u> </u>	_	Vrms
Isolation Voltage	BV_S	AC, 1 second, in oil		5000	_	VIIIIS
		DC, 1 minute, in oil	<u> </u>	5000	_	Vdc

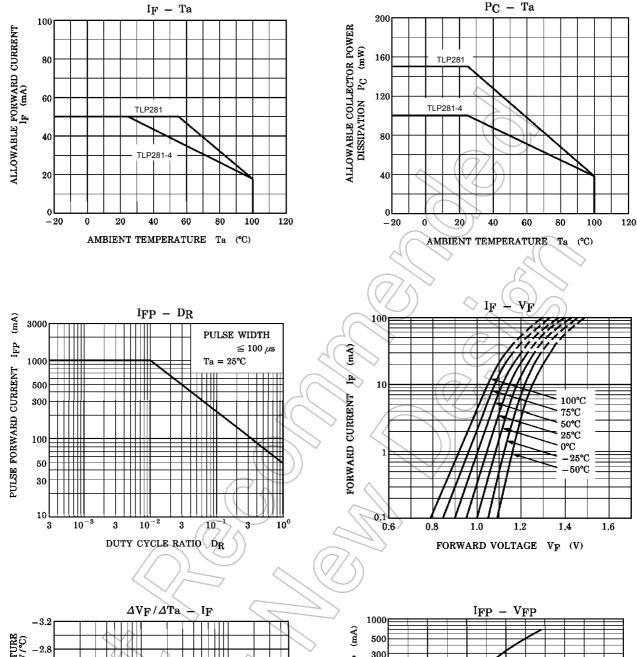
Switching Characteristics (Ta = 25°C)

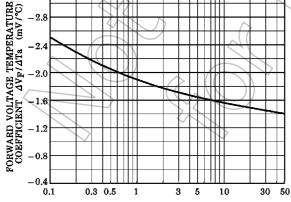
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Rise Time	(t _r)		_	2	_	
Fall Time	tr	$V_{CC} = 10 \text{ V}, I_{C} = 2 \text{ mA}$ $R_{L} = 100\Omega$	_	3	_	
Turn-On Time	() t _{on}	$R_L = 100\Omega$	_	3	_	μs
Turn-Off Time	t _{off}	(7/4)	_	3	_	
Turn-On Time	7 toN		_	2	_	
Storage Time	t _s	R_L = 1.9 kΩ (Fig.1) V _{CC} = 5 V, I _F = 16 mA	_	25	_	μs
Turn-Off Time	toff		_	40	_	

(Fig.1) SWITCHING TIME TEST CIRCUIT

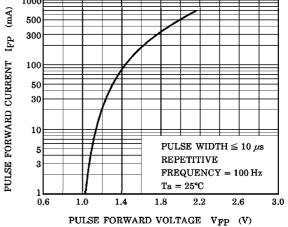






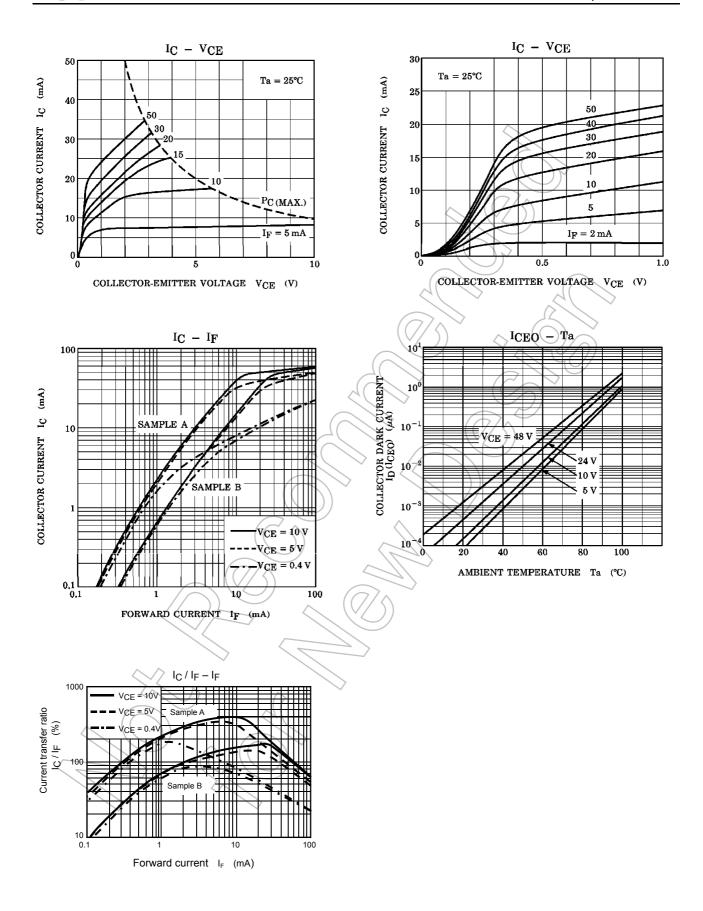


FORWARD CURRENT IF (mA)

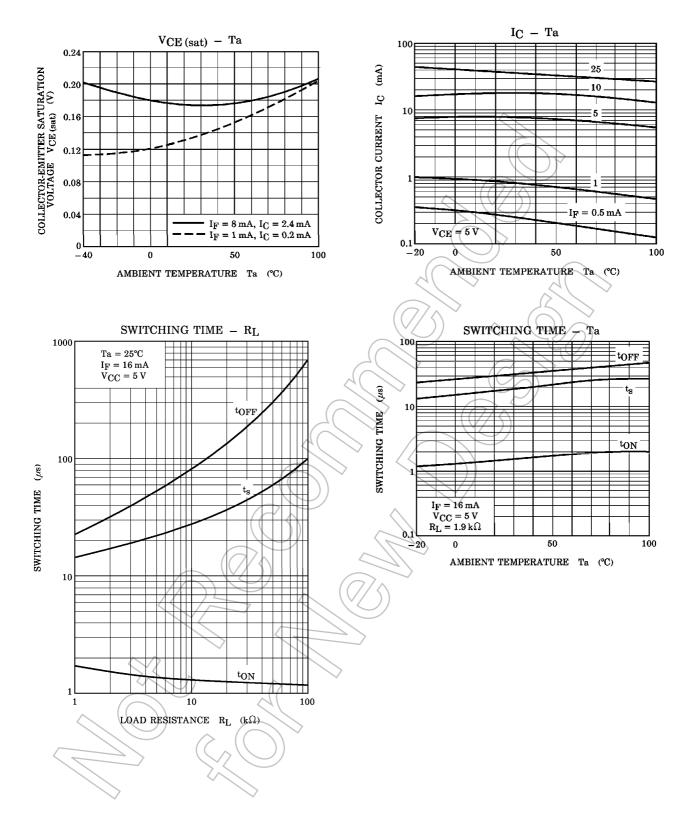


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^{*}The above graphs show typical characteristic.



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2014-09-08

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